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I HEREBY CERTIFY THAT THIS CORRESPONDENCE IS BEING DEPOSITED WITH THE UNITED STATES POSTAL SERVICE AS FIRST CLASS MAIL IN AN ENVELOPE ADDRESSED TO: COMMISSIONER FOR PATENTS, P.O. BOX 1450, ALEXANDRIA, VA 22313-1450, ON THE DATE INDICATED BELOW.

BY: Plading Mulls

Date:

MAIL STOP AMENDMENT

JUN <sup>0</sup> 8 2005

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Patent Application of:

Yuan-Chang Huang

Conf. No.: 8636

: Group Art Unit:

2811

Appln. No.:

10/717,355

Examiner:

Hung K. Vu

Filing Date:

November 19, 2003

Attorney Docket No.: 681954-65US

681954-65US (P03920003US)

Title:

CONDUCTIVE BUMPS WITH INSULATING SIDEWALLS (as amended)

## **AMENDMENT**

This Amendment is being filed in response to the Office Action dated December 2, 2005 and is being filed within the third month after the shortened statutory period set for a response to the Office Action. A Petition for a three month extension of time accompanies this paper. If any additional fees are due, charge the fees to Deposit Account No. 50-1017 (Billing No. 681954.0065).

Amendments to the Title begin on page 2 of this paper.

Amendments to the Claims begin on page 3 of this paper.

Amendments to the Abstract begin on page 6 of this paper.

**Remarks and Conclusion** begin on page 7 of this paper.

Application No. 10/717,355 Reply to Office Action of December 2, 2004

## **Amendments to the Title:**

On page 1, delete the original Title in its entirety and replace it with the following new Title:

Conductive Bumps Formed as Unitary Structures with Insulating Sidewalls and Directly Exposed Top Surfaces